

BAA 06-30 Proposer's Day Workshop Agenda

8:00-8:30	Registration and Continental Breakfast	
8:30-9:00	Welcome WBST-HPE Program Status / BAA Goals	Sharon Beermann-Curtin, DARPA
9:00-9:30	System Engineering / Integration	CAPT Michael Schwartz, Aircraft Carriers
9:30-9:45	Break, Submit Question Cards	
9:45-10:15	Device (PiN, MOSFET, IGBT) Status	Al Hefner, NIST
10:15-10:45	Independent SSPS Design Panel	John Amy, Syntek
10:45-11:00	Answer Submitted Questions	
11:00-11:30	Break, Poster Session, Submit Question Cards	
11:30-11:45	Answer Submitted Questions	
11:45-12:30	Poster Session (For Potential Proposer's to Discuss Teaming Opportunities)	
12:30	Adjourn	

Wide Bandgap Semiconductor Technology: High Power Electronics DARPA/PEO-Aircraft Carrier/ONR



BAA06-30 Proposer's Day

Sharon Beermann-Curtin
Microsystems Technology Office, DARPA
571/218-4935
16 May 2006



Proposer's Day Goals

Communication between Gov't and Proposers:

Technology status, Specific system issues, Desired outcomes, BAA specifics

Facilitated through: Presentations, Q&A sessions,

FAQ Website http://www.darpa.mil/mto/solicitations/

Communication between Industry:

Teaming opportunities

Facilitated through: Poster Session,

Teaming Website http://www.davincinetbook.com/teams/



Memorandum of Agreement

Director, DARPA / Chief of Naval Research / PEO-Aircraft Carrier

Approved by:

Program Technical Milestones

RADM Dennis M. Dwyer Program Executive Officer, Aircraft Carriers

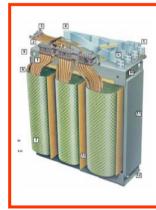
RADM Jay M. Cohen Chief of Naval Research U.S. Department of Navy

Dr. Anthony J. Tether Director, Defense Advanced Research Projects Agency U.S. Department of Defense

Task	Estimated Completion Date
Phase II Develop 10-20kV switches (IGBT's, MOSFETS) and PiN diodes. Packaging.	3Q FY06
Phase III Integrate devices and 20kHz transformer into SSPS 2.7 MVA transformer prototype.	3Q FY08
Phase IV Demonstrate 2.7 MVA SSPS	1Q FY11

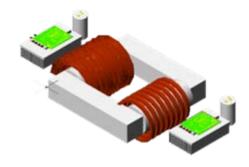


Phase III Program Goal



Low Frequency Conventional Transformer (analog)

- 2.7MVA
- 13.8kV/450V (Δ/Y) 60Hz
- · 6 tons/each
- 10 m³/each
- fixed, single output



Estimated SiC-based Solid State Power Substation (digital)

- 2.7 MVA
- 13.8kV/465V (Δ/Y) 20 kHz
- 1.7 tons/each
- 2.7 m³/each
- multiple taps/outputs

Demonstrator Transformer:

13.8kV AC – 465V AC High Frequency Solid State Power Substation (SSPS)

Program Timeline Phase I Phase II Phase III **Phase IV FY03 FY04 FY05 FY06 FY07 FY08 FY09** FY10-11 SiC materials Wafer and epi yield enhancements 10kV MOSFET/IGBT/diode SiC components 10 kV MOSFET/IGBT/diode demo packaged modules materials Manufacturability, **Producibility** 110 ea parts build 20 kHz transformer, **SSPS** preliminary design SS Power Substation **BAA Release** TRL6 Prototype build 1 May 2006 2.7 MVA SSPS lab demo Land Test

EDM (SCN)

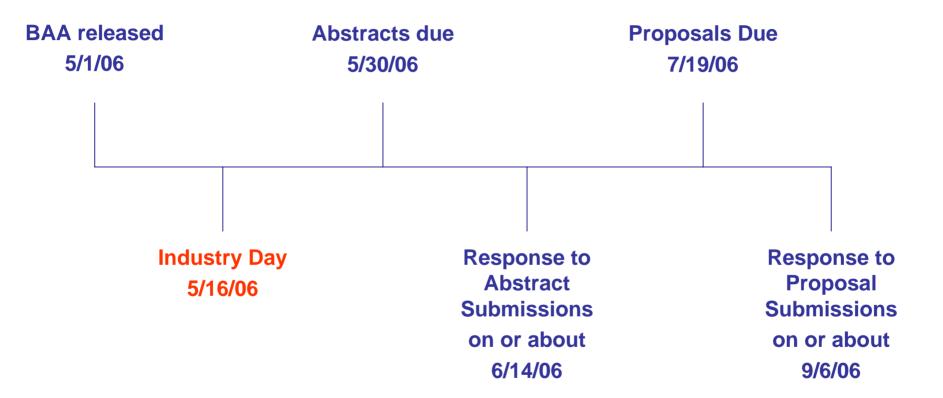
Full Power Testing Prep

System Analysis, Business Plan, Ship

Design, Integration Plan



BAA Timeline





Program Demonstrators

- Base Technical Area: Single-Phase Demonstrator
 - 13.8/√3kV 60 Hz AC conversion to 700V DC
 - High Frequency 15-25kHz
 - Thermal Management (detailed approach)
- Optional Technical Area: Three-Phase Demonstrator
 - 2.7MVA, 13.8kV 60Hz AC conversion to 465V AC
 - High Frequency 15-25kHz
 - Integrated Thermal Management

Three Phase Demonstrator Must Deliver in Dec 09



Performance Criteria

Size

Weight

Efficiency

Thermal Mgmt

Continuous Operation (150hrs)

Robustness (graceful degradation)

Fault Tolerant

Modular

MIL-STD-1399 (NAVY) Conventional Txformer



Program Challenges

- Parallel/Series SiC Devices
- Optimal Topology
- Thermal Management
- Packaging
- System Integration

BARPA BA

Evaluation Criteria

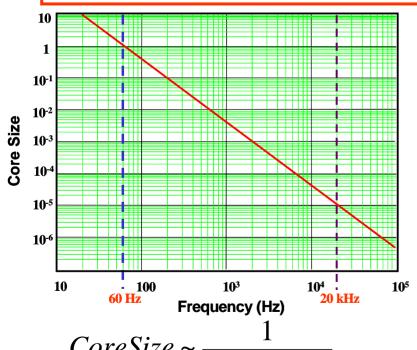
- Overall Scientific and Technical Merit
- Potential Contribution and Relevance to DARPA Mission
- Plans and Capability to Accomplish Technology Transition
- Offeror's Capabilities and Related Experience
- Cost Realism
- Schedule Realism



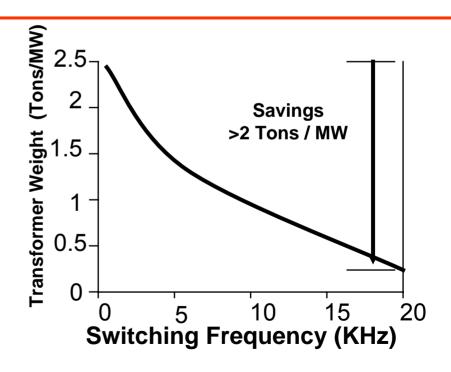
Higher Frequency Positive Ship Impact

BENEFITS:

- Precise voltage regulation-Isolate voltage spikes, voltage dips regulated with capacitive energy storage in transformer
- Unity Power Factor (20% increase in power) better control, lower temperature rises
- Fast fault detection, protection, restoration
- **DC** Distribution



$$CoreSize \sim \frac{1}{Frequency}$$



Silicon Carbide Reduces Transformer Weight by ~ 2 Tons per Megawatt of Power